



ES10A-ES10J

Surface Mount Superfast Rectifiers

Features

- ◆ The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- ◆ Idea for printed circuit board
- ◆ Glass passivated Junction chip
- ◆ Low reverse leakage
- ◆ High forward surge current capability
- ◆ High temperature soldering guaranteed
260°C/10 seconds at terminals

Mechanical Data

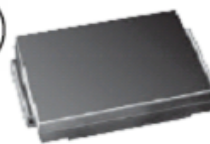
Case : Molded plastic body

Terminals : Solder plated, solderable per MIL-STD-750, Method 2026

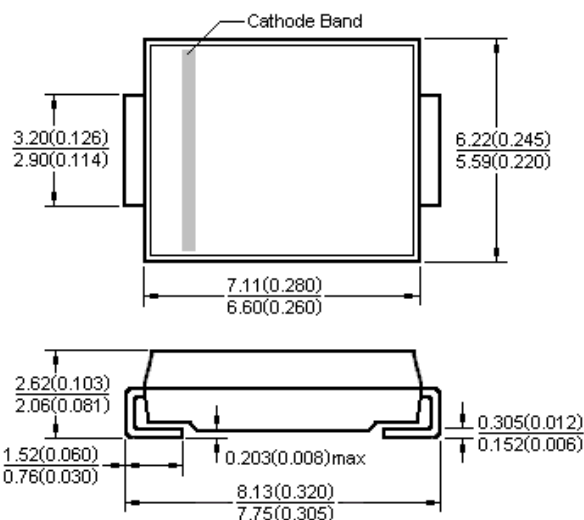
Polarity : Polarity symbol marking on body

Mounting Position : Any

Weight : 0.008 ounce, 0.225 grams



SMC (DO-214AB)



Dimensions in millimeters and (inches)

Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified. Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter	SYMBOLS	ES10A	ES10B	ES10C	ES10D	ES10F	ES10G	ES10J	UNITS
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	150	200	300	400	600	V
Maximum RMS voltage	V _{RMS}	35	70	105	140	210	280	420	V
Maximum DC blocking voltage	V _{DC}	50	100	150	200	300	400	600	V
Maximum average forward rectified current at T _L =100°C	I _(AV)	10.0							A
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	200.0							A
Maximum instantaneous forward voltage at 10.0A	V _F	1.0				1.3		1.7	V
Maximum DC reverse current T _A =25°C at rated DC blocking voltage T _A =125°C	I _R	5.0 500							μA
Maxinum reverse recovery time(Note 1)	T _{rr}	35							ns
Typical junction capacitance (Note2)	C _J	93.0							pF
Typical thermal resistance	R _{qJA}	47.0							°C/W
Operating junction and storage temperature range	T _J ,T _{STG}	-55 to +150							°C

Note: 1.Reverse recovery time test condition: $I_F=0.5\text{A}$ $I_R=1.0\text{A}$ $I_{rr}=0.25\text{A}$
2.Measured at 1MHz and applied reverse voltage of 4.0V D.C.



ES10A-ES10J

Surface Mount Superfast Rectifiers

Ratings And Characteristic Curves

FIG. 1- DERATING CURVE OUTPUT RECTIFIED CURRENT

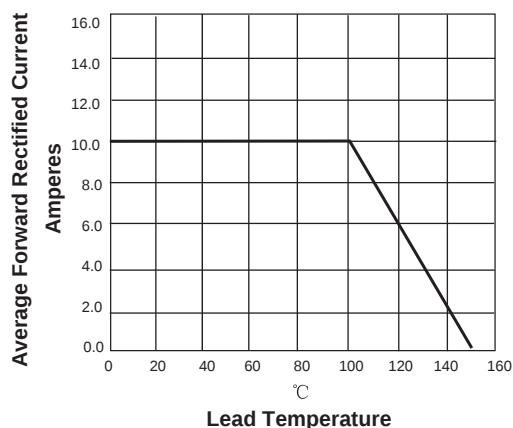


FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT PERLEG

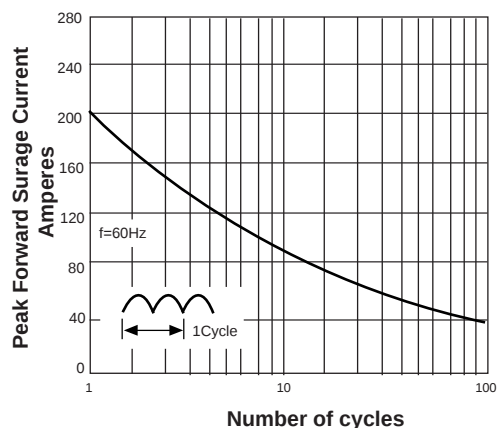


FIG. 3-TYPICAL FORWARD VOLTAGE CHARACTERISTICS

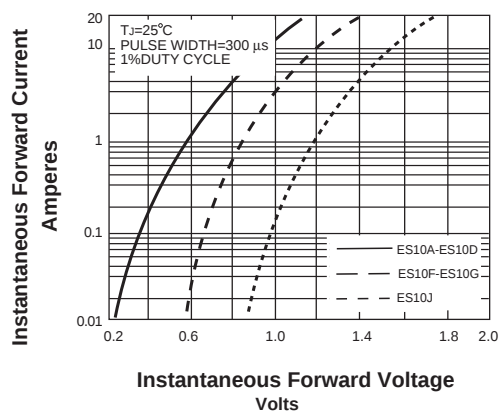
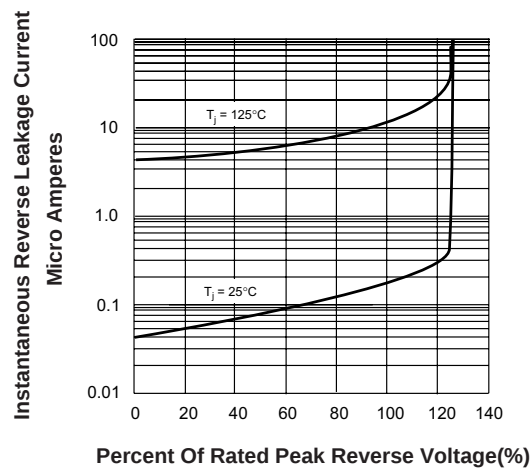
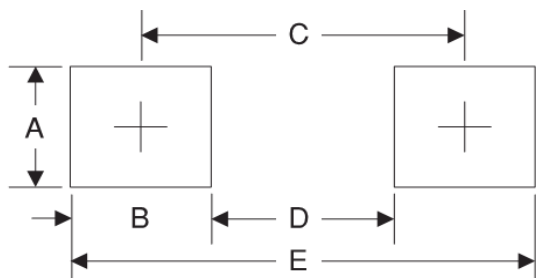


FIG. 4-TYPICAL REVERSE LEAKAGE CHARACTERISTICS



Suggested Pad Layout



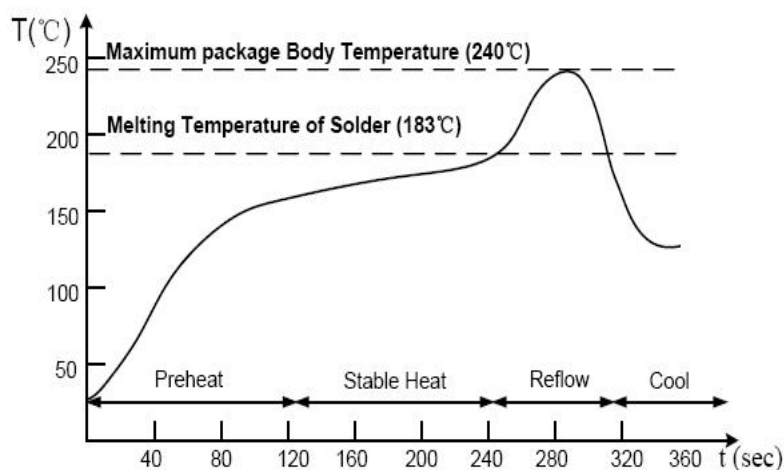
Symbol	Unit (mm)	Unit (inch)
A	3.30	0.130
B	2.50	0.098
C	6.80	0.268
D	4.40	0.173
E	9.40	0.370



ES10A-ES10J

Surface Mount Superfast Rectifiers

Suggested Soldering Temperature Profile

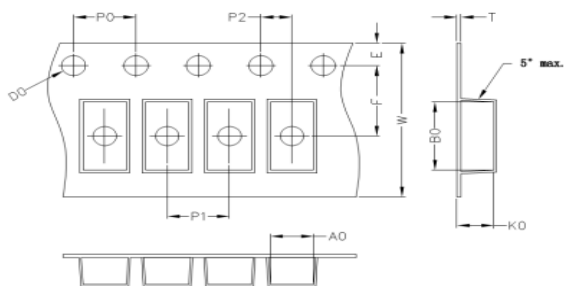


Note

- Recommended reflow methods: IR, vapor phase oven, hot air oven, wave solder.
- The device can be exposed to a maximum temperature of 265°C for 10 seconds.
- Devices can be cleaned using standard industry methods and solvents.
- If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

Package Information

Carrier Dimension(mm)



A0	B0	K0	D0	E	F
6.05	8.31	2.54	1.55	1.75	7.50
P0	P1	P2	T	W	Tolerance
4.0	8.0	2.0	0.25	16	0.1

Package Specifications

Package	Reel Size	Reel DIA. (mm)	Q'TY/Reel (Kpcs)	Box Size (mm)	QTY/Box (Kpcs)	Carton Size (mm)	Q'TY/Carton (Kpcs)
SMC	13'	330	3.0	340	6.0	360*360*360	48